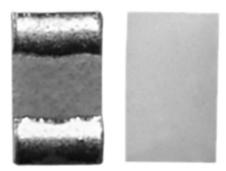
RoHS

<u>GREEN</u>



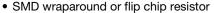
# **High Frequency 50 GHz Thin Film Chip Resistor**



Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz.

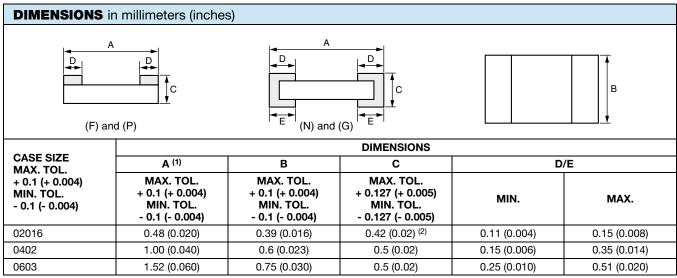
#### **FEATURES**

- · Operating frequency 50 GHz
- Thin film microwave resistors



- Small size, down to 20 mils by 16 mils
- · Edged trimmed block resistors
- Pure alumina substrate (99.5 %)
- Ohmic range: 10R to 500R
- · Design kits available
- Small internal reactance (LC down to 1 × 10<sup>-24</sup>)
- Tolerance 1 %, 2 %, 5 %, 10 %
- TCR: 100 ppm/°C in (- 55 °C, + 155 °C) temperature range
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

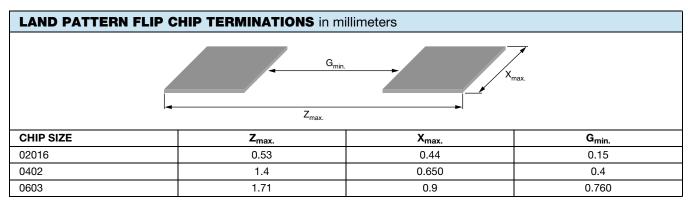
STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	SIZE	RESISTANCE RANGE Ω	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C		
CH02016	02016	10 to 500	0.030	30	1, 2, 5, 10	100		
CH0402	0402	10 to 500	0.050	37	1, 2, 5, 10	100		
CH0603	0603	10 to 500	0.125	50	1, 2, 5, 10	100		



#### Notes

- (1) For CH0402 and CH0603 with F termination, A dimension is increased by 0.2 mm
- (2) + or 0.07 mm





#### Note

Suggested land pattern: According to IPC-7351

Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard"

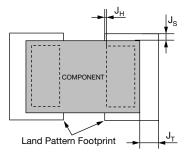
Example of land pattern: Fabrication allowance, assembly location and min. or max. level density board are not included in the exemple bellow.

According to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard":

$$Z_{max.} = A_{min.} + 2J_T + \sqrt{(C_A^2 + F^2 + P^2)}$$
 with C: "Unilateral profile tolerance for the component";

$$G_{min.} = F_{max.} + 2J_H - \sqrt{(C_F^2 + F^2 + P^2)}$$
 F: "Unilateral profile tolerance for the board land pattern";

$$X_{max.} = B_{min.} + 2J_S + \sqrt{(C_B^2 + F^2 + P^2)}$$
 and P: "Diameter of true position placement accuracy to the center of land pattern".



For rectangular component Flip-Chip mounting, we suggest:

JT (TOE)	0 mm
JH (HELL)	0 mm
JS (SDE)	0 mm

WRAPAROUND TERMINATIONS in millimeters					
Z <sub>max.</sub>					
CHIP SIZE	Z <sub>max</sub> .	G <sub>min.</sub>	X <sub>max</sub> .		
0402	1.55	0.15	0.73		
0603	2.37	0.35	0.98		

TOLERANCE VS. OHMIC VALUES						
Ohmic range	$10~\Omega \le R < 50~\Omega$	50 Ω ≤ <i>R</i> < 100 Ω	100 Ω $\leq$ $R$ $\leq$ 500 Ω <sup>(1)</sup>			
Tolerance	5 %, 10 %	2 %, 5 %, 10 %	1 %, 2 %, 5 %, 10 %			

### Note

(1) Best tolerance for 100  $\Omega$  to 500  $\Omega$  in 02016 is 2 %







### PREFERRED MODELS AND VALUES

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances. Recommended Values:

10R/18R/25R/50R/75R/100R/150R/180R/200R/250R/330R/500R

Those values are available with a MOQ of 100 pieces.

Other values can be ordered upon request, but higher MOQ will apply: 1000 pieces for CH02016, 500 pieces for CH0402, 250 pieces for CH0603.

Recommended terminations:

Recommended tolerance:

2 %

**Design kits** are available Ex Stock in CH02016 and CH0402 sizes. There are 20 pieces per recommended value. F termination. 5 % tolerance.

Those kits are packaged in pieces of tape and delivered in ESD bags.

#### **PACKAGING**

Standard packaging is waffle pack for sizes 0402 and 0603. Paper tape for size 02016.

Plastic tape and reel is available for 0402 and 0603 (low conductivity) or paper tape under request.

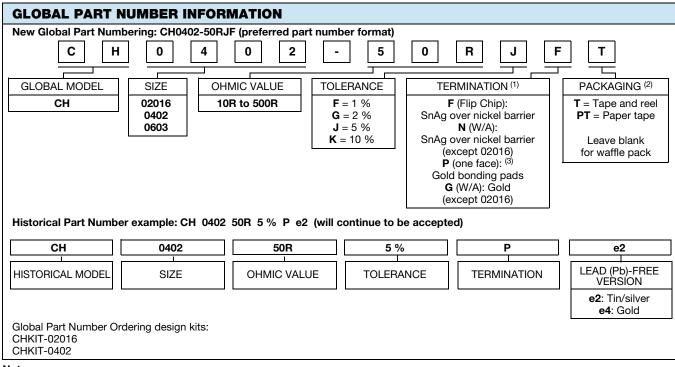
Depending on the type of terminations, parts will be packed differently:

#### One face:

- · Gold terminations: Active face up
- Tin/silver termination: Active face down

#### Note

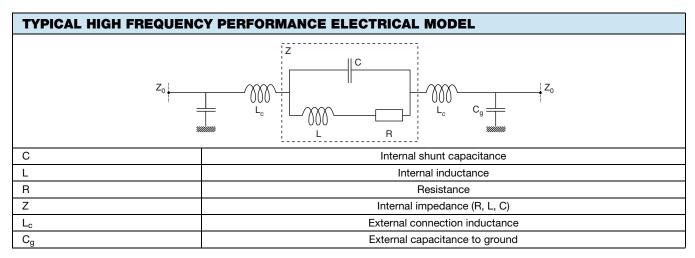
• Please refer to Vishay Sfernice Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Products" for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies



#### **Notes**

- (1) 02016 not available with N and G termination
- (2) 02016 paper tape only available
- (3) Gold termination for application in hermetic package





The complex impedance of the chip resistor is given by the following equations:

$$Z = \frac{R + j\omega(L - R^{2}C - L^{2}C\omega^{2})}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]}$$

$$\frac{[Z]}{R} = \frac{1}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]} \times \sqrt{1 + \left[\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}\right]^{2}}$$

$$\theta = \tan^{-1}\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}$$

#### Notes

- $\omega = 2 \times \pi \times f$
- f: Frequency

The chip resistor itself is purely resistive when  $R = \sqrt{\frac{L}{C}}$ . The smaller the L x C product the greater the frequency range over which the resistor looks approximately resistive.

This can be seen on the graphs showing the ratio  $\frac{|Z|}{R}$  versus frequency.

R, L and C are relevant to the chip resistor itself.

 $L_{\text{c}}$  and  $C_{\text{g}}$  also depends on the way the chip resistor is mounted.

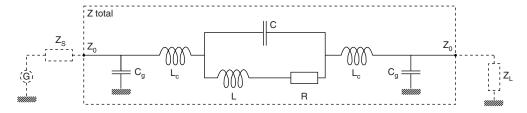
It is important to notice that after assembly the external reactance of L<sub>c</sub> and C<sub>q</sub> will be combined to internal reactance of L and C. This combination can upgrade or downgrade the HF behaviour of the component.

This is why we are displaying two sets of data:

- $\frac{[Z]}{R}$  versus frequency curves which aims to show at a glance the intrinsic HF performance of a given chip resistor
- S-parameters versus frequency curves relevant to chip resistor when assembled on ideal Z0 impedance transmission line

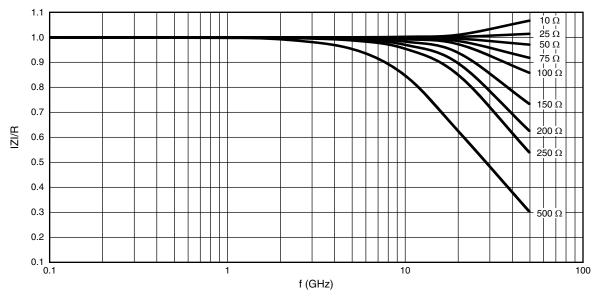
These lines are terminated with adapted source and load impedance respectively  $Z_s$  and  $Z_l$  with  $Z_0 = Z_L = Z_s$  (for others configurations please consult us).

Equivalent circuit for S-parameters:

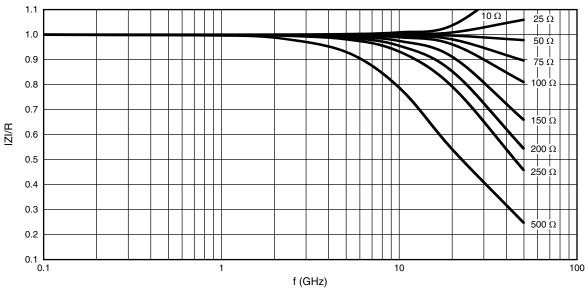


S-parameters are computed taking into account all the resistive, inductive and capacitive elements (Z total) and  $Z_0 = Z_L = Z_s = R$ .

## **INTERNAL IMPEDANCE CURVES**

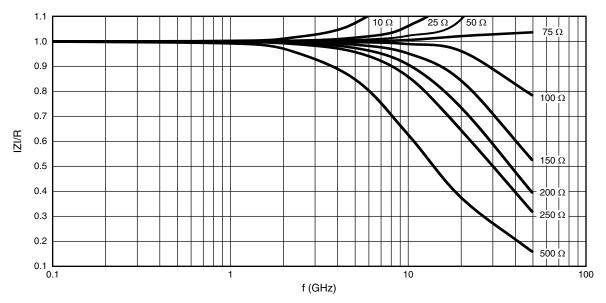


Internal impedance curve for 02016 size (F and P terminations)

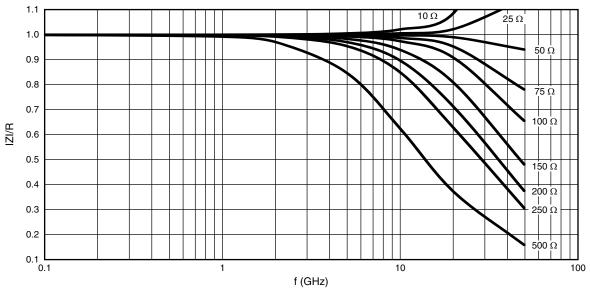


Internal impedance curve for 0402 size (F and P terminations)

## **INTERNAL IMPEDANCE CURVES**

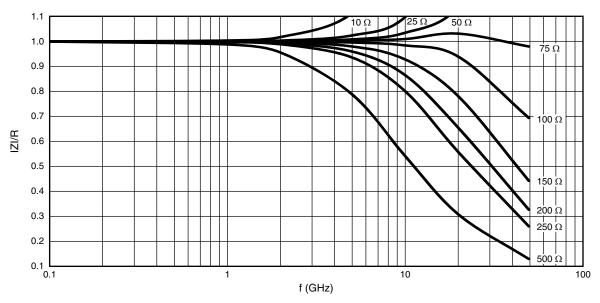


Internal impedance curve for 0402 size (N and G terminations)



Internal impedance curve for 0603 size (F and P terminations)

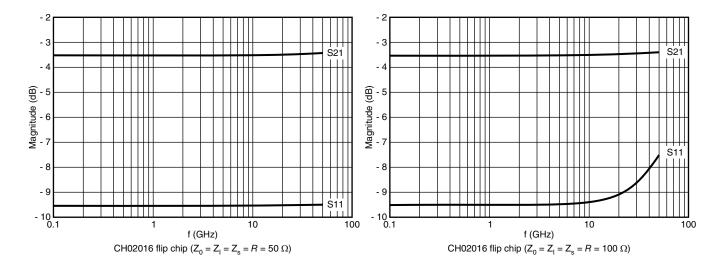
## **INTERNAL IMPEDANCE CURVES**



Internal impedance curve for 0603 size (N and G terminations)

## **S-PARAMETER**

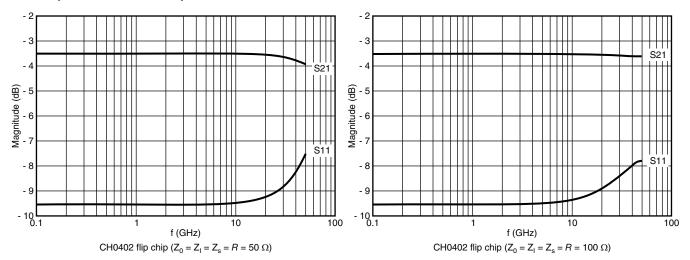
### CH02016 (F and P Terminations)



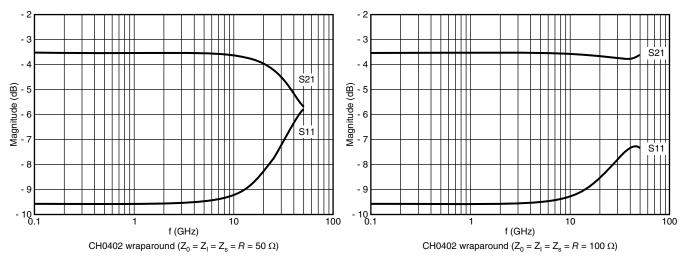


### S-PARAMETER

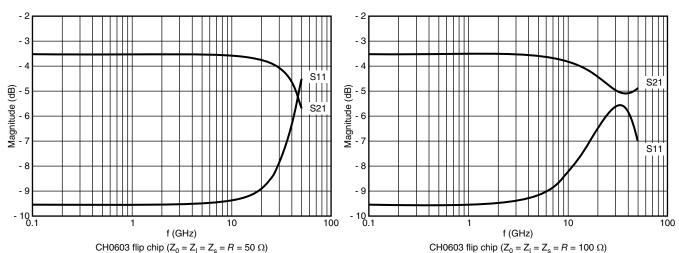
### CH0402 (F and P Terminations)



# CH0402 (N and G Terminations)



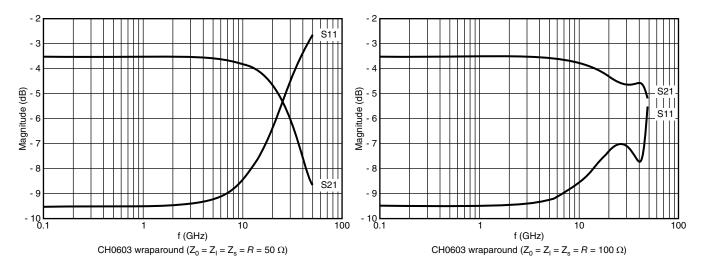
## CH0603 (F and P Terminations)





## **S-PARAMETER**

# CH0603 (N and G Terminations)





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